



Parameter	Rating	Units
Breakdown Voltage - BV_{CEO}	30	V_P
Current Transfer Ratio	200	%
Saturation Voltage	0.5	V
Input Control Current	0.2	mA

Features

- Small 4-pin Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 5000V_{rms} Input/Output Isolation
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable

Applications

- Sensor Circuitry
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment: Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Description

The CPC1303 is a unidirectional input optocoupler with a single-transistor output, which uses optically coupled technology to provide an enhanced 5000V_{rms} isolation barrier between the input and the output. The optically coupled output is controlled by a highly efficient GaAlAs infrared LED.

This optocoupler satisfies the PD output requirements of the CPC1466.

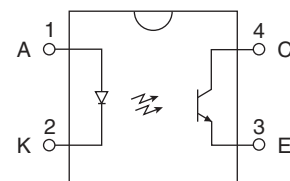
Approvals

- UL Pending
- EN/IEC 60950-1 Compliant
- CSA Certified Component: Certificate # 043639

Ordering Information

Part Number	Description
CPC1303G	4-Pin DIP (100/Tube)
CPC1303GR	4-Pin Surface Mount (100/Tube)
CPC1303GRTR	4-Pin Surface Mount (1000/Reel)

Pin Configuration



Absolute Maximum Ratings

Parameter	Ratings	Units
Breakdown Voltage	30	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Power Dissipation ²		
Input ¹	150	mW
Phototransistor ²	150	
Isolation Voltage, Input to Output	5000	V _{rms}
Operating Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

¹ Derate Linearly 1.33 mW/°C
² Derate Linearly 2.00 mW/°C

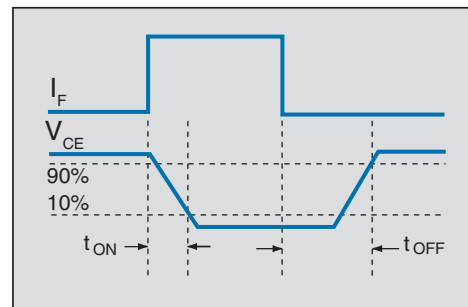
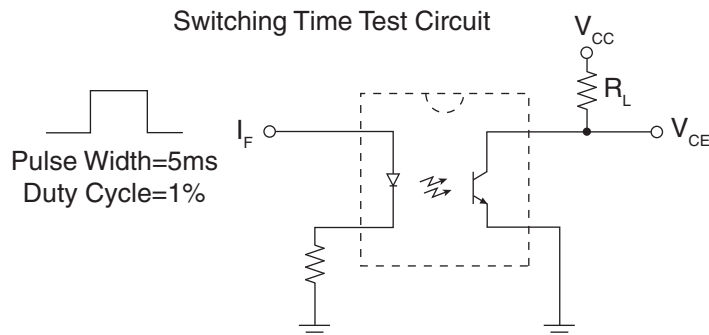
Electrical absolute maximum ratings are at 25°C

Electrical Characteristics

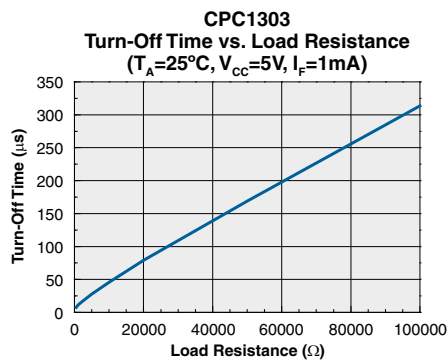
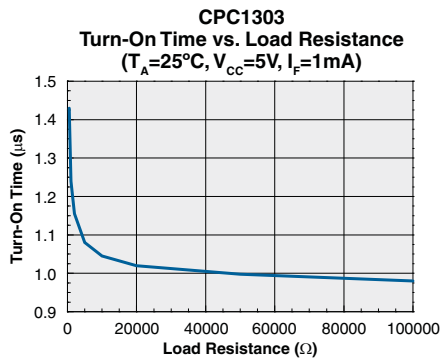
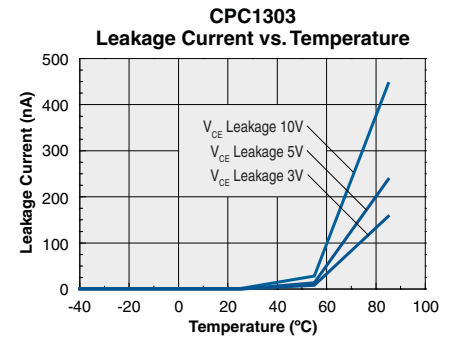
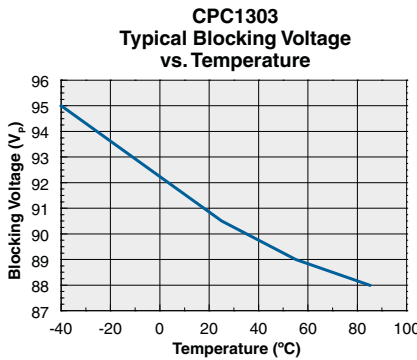
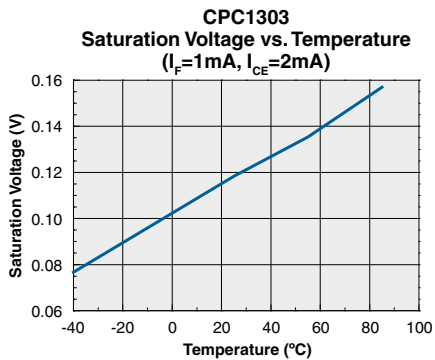
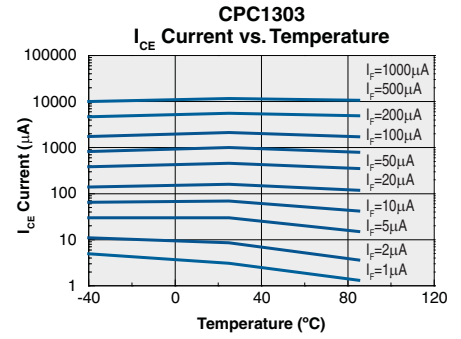
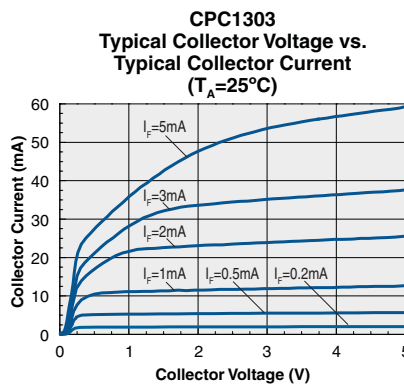
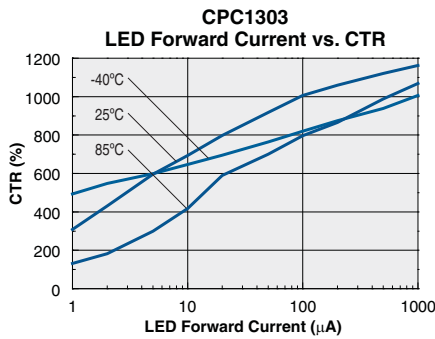
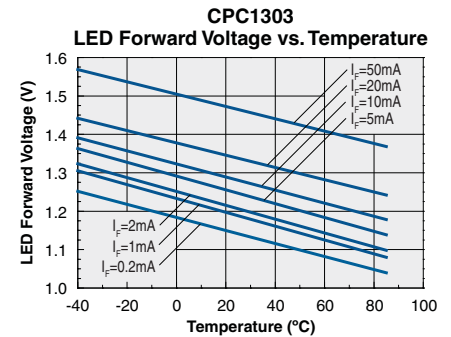
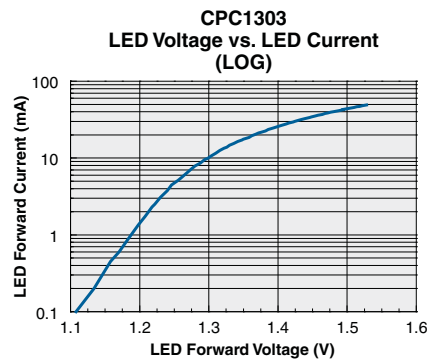
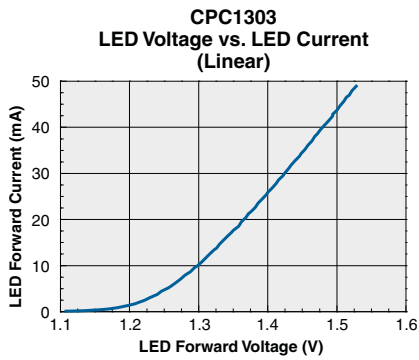
Parameters	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Phototransistor Breakdown Voltage	I _{CEO} =10μA	BV _{CEO}	30	-	-	V _P
Phototransistor Output (Dark) Current	V _{CEO} =5V, I _F =0mA	I _{CEO}	-	25	500	nA
Saturation Voltage	I _C =0.4mA, I _F =0.2mA	V _{CEsat}	-	0.1	0.45	V
	I _C =10mA, I _F =10mA		-	0.12	0.5	V
Current Transfer Ratio	I _F =0.2mA, V _{CE} =0.5V	CTR	200	1000	2500	%
Output Capacitance	V _{CEO} =25V, f=1MHz	C _{OUT}	-	6	-	pF
Input Characteristics @ 25°C						
Input Control Current	I _C =0.4mA, V _{CE} =0.5V	I _F	-	-	0.2	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Input Reverse Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics @ 25°C						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

Switching Characteristics @ 25°C

Characteristic	Symbol	Test Condition	Typ	Units
Turn-On Time	t _{ON}	V _{CC} =5V, I _F =1mA, R _L =500Ω	2	μs
Turn-Off Time	t _{OFF}		8	



PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Soldering

For proper assembly, the component must be processed in accordance with the current revision of IPC/JEDEC standard J-STD-020. Failure to follow the recommended guidelines may cause permanent damage to the device resulting in impaired performance and/or a reduced lifetime expectancy.

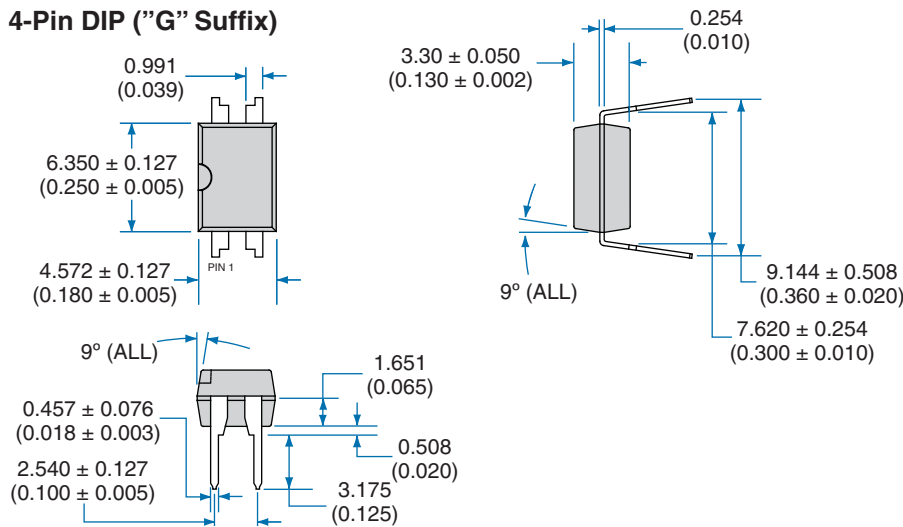
Washing

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

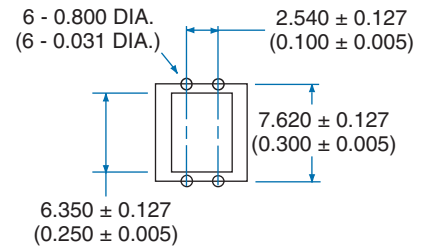


MECHANICAL DIMENSIONS

4-Pin DIP ("G" Suffix)

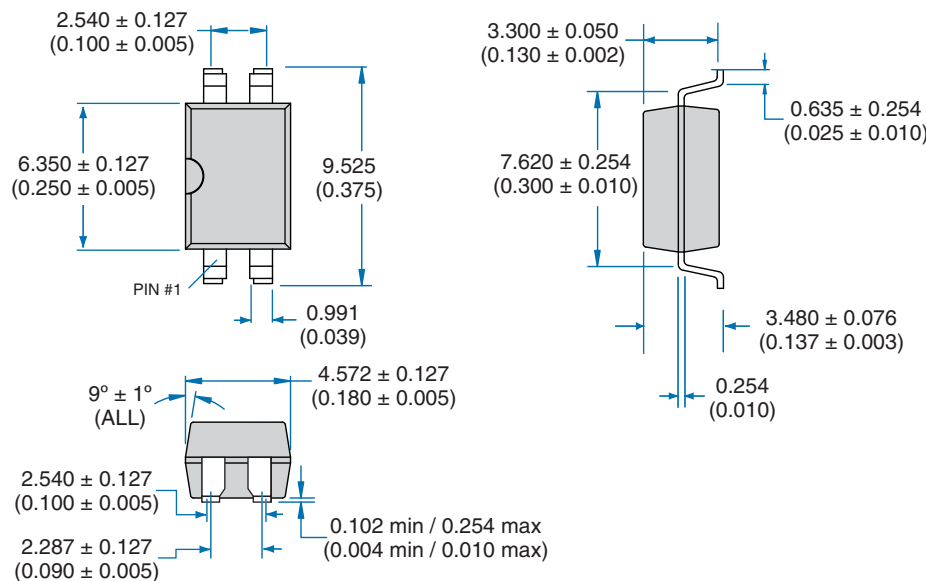


PC Board Pattern (Top View)

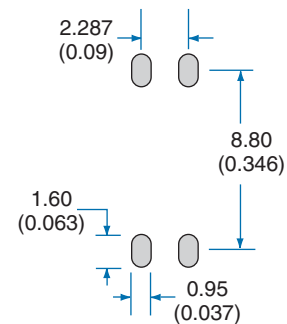


Dimensions
mm
(inches)

4-Pin Surface Mount ("GR" Suffix)

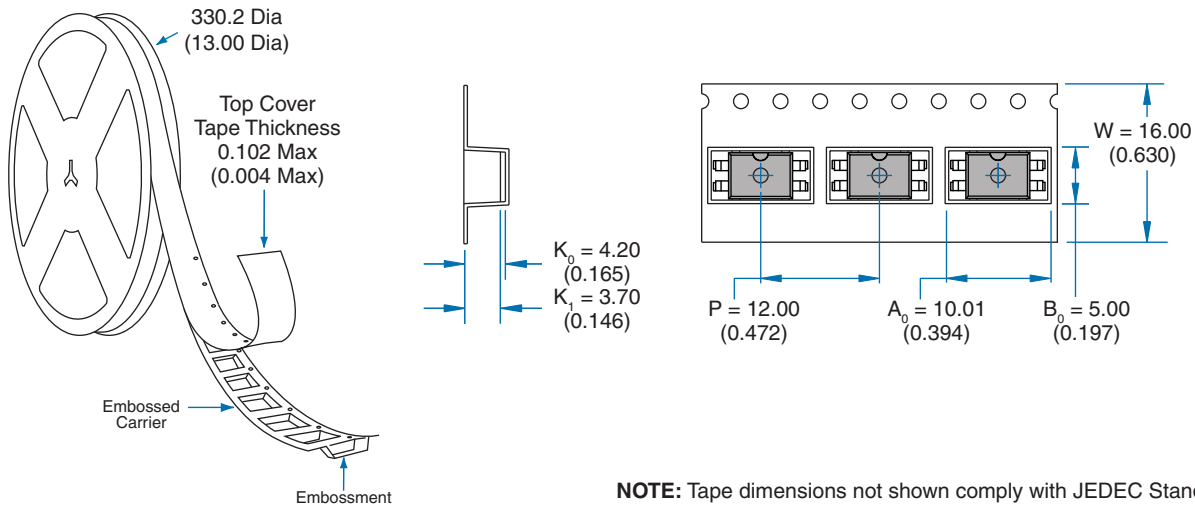


Recommended PCB Land Pattern



Dimensions
mm
(inches)

Tape and Reel Packaging for 4-Pin Surface Mount Package



Dimensions
mm
(inches)

NOTE: Tape dimensions not shown comply with JEDEC Standard EIA-481-2

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